

## Excellent Integrated System Limited

Stocking Distributor

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[Powerex Inc.](#)  
[CM600DU-5F](#)

For any questions, you can email us directly:

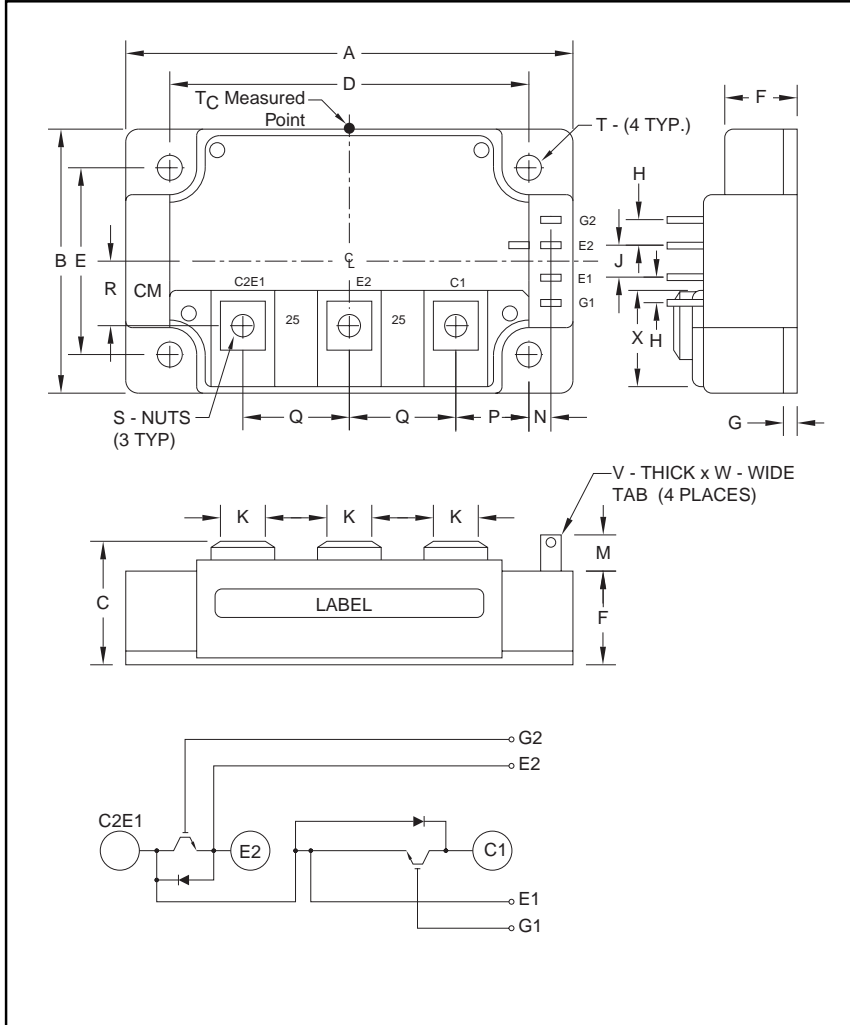
[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)



Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

**CM600DU-5F**

**Dual IGBTMOD™  
F-Series Module  
600 Amperes/250 Volts**



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.33	110.0
B	3.15	80.0
C	1.14 +0.04/-0.02	29.0 +1.0/-0.5
D	3.66±0.01	93.0±0.25
E	2.44±0.01	62.0±0.25
F	0.83	21.0
G	0.16	4.0
H	0.24	6.0
J	0.59	15.0
K	0.55	14.0

Dimensions	Inches	Millimeters
M	0.33	8.5
N	0.10	2.5
P	0.85	21.6
Q	0.98	25.0
R	0.86	21.75
S	M6	M6
T	0.26 Dia.	6.5 Dia.
V	0.02	0.5
W	0.110	2.79
X	1.08	27.35



**Description:**

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of two IGBT Transistors in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

**Features:**

- Low Drive Power
- Low  $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- Isolated Baseplate for Easy Heat Sinking

**Applications:**

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies
- Laser Power Supplies

**Ordering Information:**

Example: Select the complete module number you desire from the table - i.e. CM600DU-5F is a 250V ( $V_{CES}$ ), 600 Ampere Dual IGBTMOD™ Power Module.

Type	Current Rating Amperes	$V_{CES}$ Volts (x 50)
CM	600	5



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### Absolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM600DU-5F	Units
Junction Temperature	$T_j$	-40 to 150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	$V_{CES}$	250	Volts
Gate-Emitter Voltage (C-E SHORT)	$V_{GES}$	$\pm 20$	Volts
Collector Current ( $T_C = 25^\circ\text{C}$ )	$I_C$	600	Amperes
	$I_{C(rms)}$	350	Amperes (rms)
Peak Collector Current	$I_{CM}$	1200*	Amperes
Emitter Current** ( $T_C = 25^\circ\text{C}$ )	$I_E$	600	Amperes
	$I_{E(rms)}$	350	Amperes (rms)
Peak Emitter Current**	$I_{EM}$	1200*	Amperes
Maximum Collector Dissipation ( $T_C = 25^\circ\text{C}$ , $T_j \leq 150^\circ\text{C}$ )	$P_C$	1100	Watts
Mounting Torque, M6 Main Terminal	–	40	in-lb
Mounting Torque, M6 Mounting	–	40	in-lb
Weight	–	580	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	$V_{iso}$	2500	Volts

\* Pulse width and repetition rate should be such that the device junction temperature ( $T_j$ ) does not exceed  $T_{j(max)}$  rating.

\*\*Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

### Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	$I_{CES}$	$V_{CE} = V_{CES}$ , $V_{GE} = 0V$	–	–	1	mA
Gate Leakage Current	$I_{GES}$	$V_{GE} = V_{GES}$ , $V_{CE} = 0V$	–	–	0.5	$\mu\text{A}$
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 60\text{mA}$ , $V_{CE} = 10V$	3.0	4.0	5.0	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 600\text{A}$ , $V_{GE} = 10V$ , $T_j = 25^\circ\text{C}$	–	1.2	1.7	Volts
		$I_C = 600\text{A}$ , $V_{GE} = 10V$ , $T_j = 125^\circ\text{C}$	–	1.1	–	Volts
Total Gate Charge	$Q_G$	$V_{CC} = 100V$ , $I_C = 600\text{A}$ , $V_{GE} = 10V$	–	2200	–	nC
Emitter-Collector Voltage**	$V_{EC}$	$I_E = 600\text{A}$ , $V_{GE} = 0V$	–	–	2.0	Volts

\*\*Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

### Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	$C_{ies}$		–	–	170	nf
Output Capacitance	$C_{oes}$	$V_{CE} = 10V$ , $V_{GE} = 0V$	–	–	11	nf
Reverse Transfer Capacitance	$C_{res}$		–	–	5.7	nf
Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 100V$ , $I_C = 600\text{A}$ ,	–	–	850	ns
Rise Time	$t_r$	$V_{GE1} = V_{GE2} = 10V$ ,	–	–	600	ns
Turn-off Delay Time	$t_{d(off)}$	$R_G = 4.2\Omega$ ,	–	–	1100	ns
Fall Time	$t_f$	Inductive Load	–	–	500	ns
Diode Reverse Recovery Time**	$t_{rr}$	Switching Operation	–	–	300	ns
Diode Reverse Recovery Charge**	$Q_{rr}$	$I_E = 600\text{A}$	–	20.0	–	$\mu\text{C}$

\*\*Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).



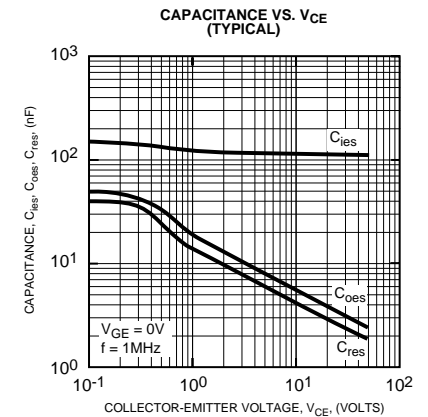
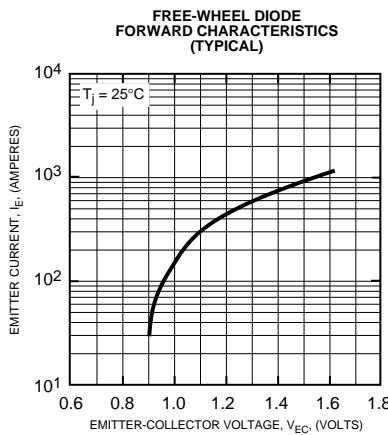
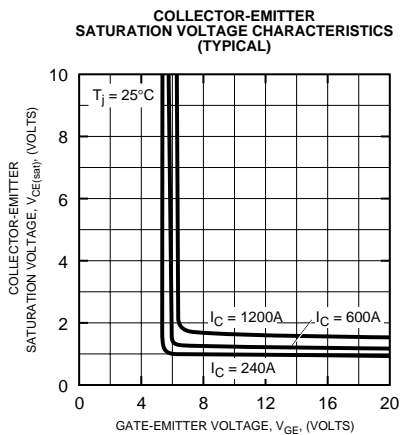
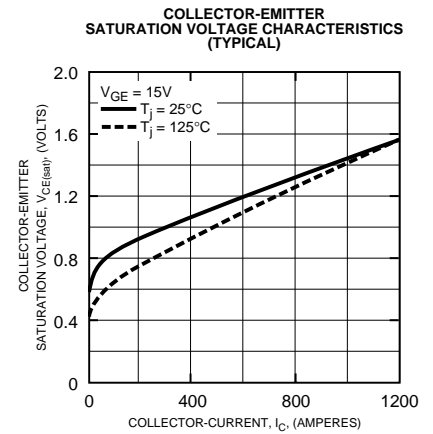
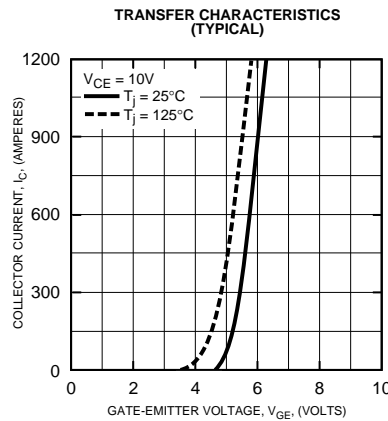
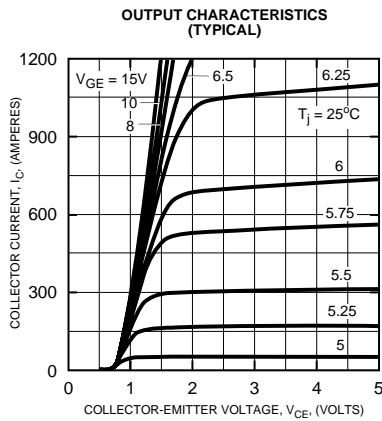
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**Thermal and Mechanical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT 1/2 Module	–	–	0.11	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)R}$	Per FWDi 1/2 Module	–	–	0.20	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	0.020	–	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT 1/2 Module	–	–	0.05	$^\circ\text{C/W}$

$T_C$  Reference Point Under Chip





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